

# SM6T250CAY

### Automotive 600 W Transil™

Datasheet - production data

#### Complies with the following standards

- IEC 61000-4-2 exceeds level 4:
  - 30 kV (air discharge)
  - 30 kV (contact discharge)
- ISO 10605, C = 330 pF, R = 330 Ω exceeds level 4:
  - 30 kV (air discharge)
  - 30 kV (contact discharge)
- ISO 7637-2

### Description

The SM6T250CAY Transil series has been designed to protect sensitive automotive circuits against surges defined in ISO 7637-2 and against electrostatic discharges according to IEC 61000-4-2 and ISO 10605.

The planar technology makes this device compatible with high-end circuits where low leakage current and high junction temperature are required to provide reliability and stability over time. SM6T250CAY is packaged in SMB (SMB footprint in accordance with IPC 7531 standard).

FeaturesPeak pulse power:

Bidirectional

SMB (JEDEC DO-214AA)

- 600 W (10/1000 μs)
  - 4 kW (8/20 µs)
- Stand-off voltage 213 V
- Bidirectional type
- Low leakage current:
- 200 nA at 25 °C
  - 1 μA at 85 °C
- Operating T<sub>i max</sub>: 175 °C
- High power capability at Ti max
- JEDEC registered package outline
- Resin meets UL 94, V0
- AEC-Q101 qualified

TM: Transil is a trademark of STMicroelectronics

This is information on a product in full production.

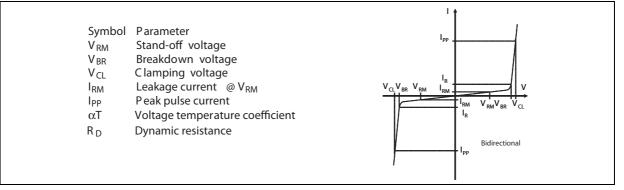
### 1 Characteristics

Symbol		Value	Unit		
V <sub>PP</sub>	Peak pulse voltage	ISO 10605 (C = Contact discha Air discharge IEC61000-4-2: Contact discha Air discharge		30 30 30 30 30	kV
P <sub>PP</sub>	Peak pulse power dissi	T <sub>j</sub> initial = T <sub>amb</sub>	600	W	
Тj	Operating junction tem	-55 to 175	°C		
T <sub>stg</sub>	Storage temperature ra	-65 to 175	°C		
ΤL	Maximum lead tempera	260	°C		

Table 1.	Absolute	maximum	ratings	(T <sub>amb</sub> = 25 °C	2)
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1. For a surge greater than the maximum values, the diode will fail in short-circuit.

#### Figure 1. Electrical characteristics - definitions



#### Figure 2. Pulse definition for electrical characteristics

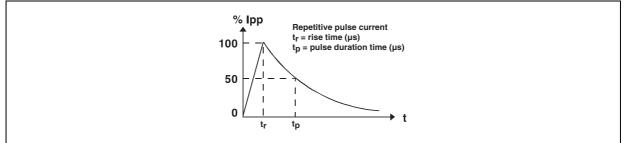




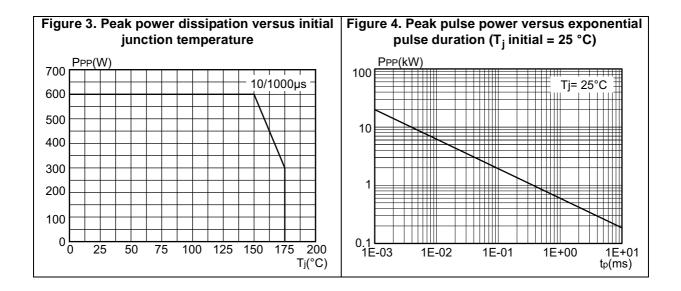
Table 2. Electrical characteristics, parameter values (Tamb = 25° 0)														
Order code	I <sub>RM</sub> max at V <sub>RM</sub>			V <sub>BR</sub> at I <sub>R</sub> <sup>(1)</sup> V <sub>CL</sub> at I <sub>PP</sub> 10/1000 μs		R <sub>D</sub> <sup>(2)</sup> 10/100 µs	V <sub>CL</sub> a 8/2(	it I <sub>PP</sub> ) µs	R <sub>D</sub> <sup>(2)</sup> 8/20 μs	αΤ				
	25	85		min.	tup	max.		max.			max.			max.
	°(	)			typ.	max.					max.			max.
	nA	μA	v		V		mA	V <sup>(3)</sup>	Α	Ω	V <sup>(3)</sup>	Α	Ω	10-4/°C
SM6T250CAY	200	1	213	237	250	263	1	344	1.75	53.7	400	10	15	11

Table 2. Electrical characteristics, parameter values ( $T_{amb} = 25 \text{ °C}$ )

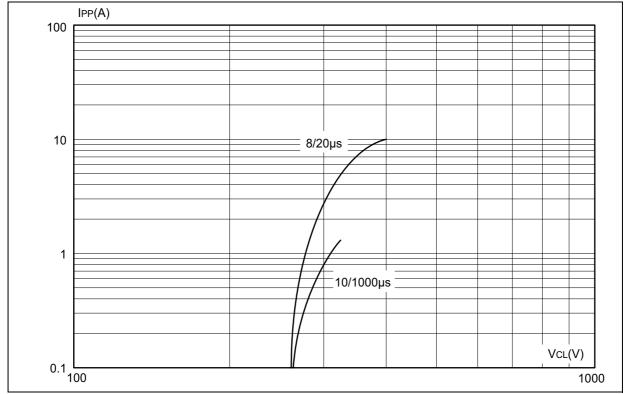
1. Pulse test: t<sub>p</sub> < 50 ms

2. To calculate maximum clamping voltage at another surge level, use the following formula:  $V_{CLmax} = V_{CL} - R_D x (I_{PP} - I_{PPappli})$  where  $I_{PPappli}$  is the surge current in the application.

3. To calculate V<sub>BR</sub> or V<sub>CL</sub> versus junction temperature, use the following formulas: V<sub>BR</sub> @ T<sub>J</sub> = V<sub>BR</sub> @ 25°C x (1 +  $\alpha$ T x (T<sub>J</sub> - 25)) V<sub>CL</sub> @ T<sub>J</sub> = V<sub>CL</sub> @ 25°C x (1 +  $\alpha$ T x (T<sub>J</sub> - 25))

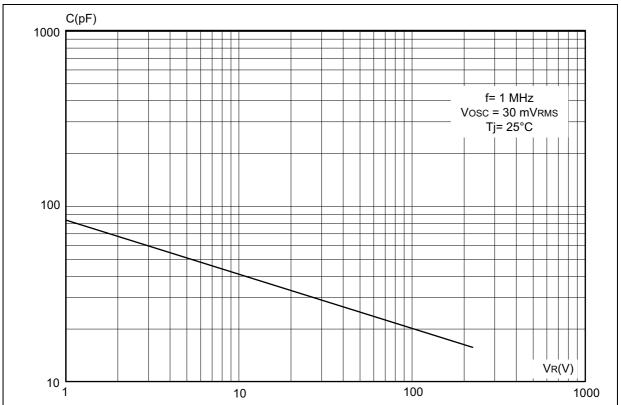






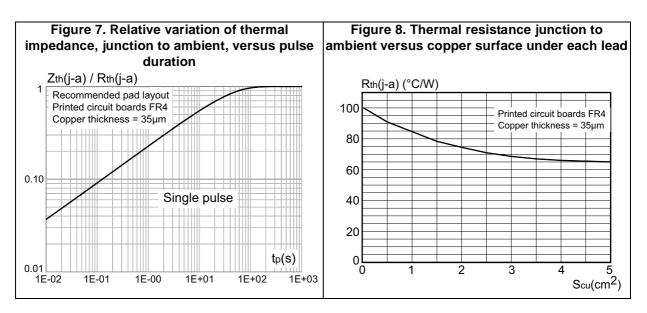
#### Figure 5. Clamping voltage versus peak pulse current exponential waveform (maximum values)

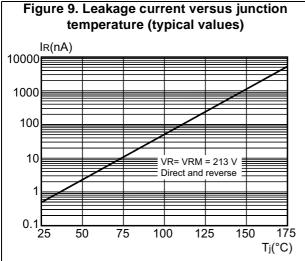
Figure 6. Junction capacitance versus reverse applied (typical values)













### 2 Application and design guidelines

More information is available in the ST Application note AN2689 "Protection of automotive electronics from electrical hazards, guidelines for design and component selection".

### **3** Packaging information

- Case: JEDEC DO-214AA molded plastic over planar junction
- Terminals: solder plated, solderable as per MIL-STD-750, Method 2026
- Polarity: for unidirectional types the band indicates cathode
- Epoxy meets UL94, V0
- Lead-free package

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK<sup>®</sup> packages, depending on their level of environmental compliance. ECOPACK<sup>®</sup> specifications, grade definitions and product status are available at: *www.st.com.* ECOPACK<sup>®</sup> is an ST trademark.

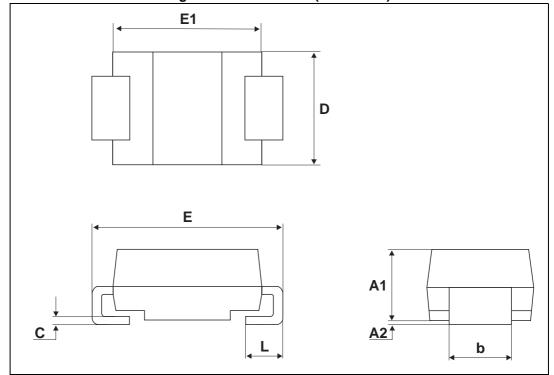
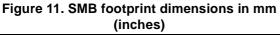




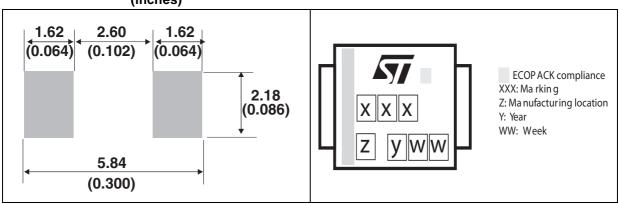


	Table	Sime unitensions	(values)							
		Dimensions								
Ref.	Millim	neters	Inches							
	Min.	Max.	Min.	Max.						
A1	1.90	2.45	0.075	0.096						
A2	0.05	0.20	0.002	0.008						
b	1.95	2.20	0.077	0.087						
С	0.15	0.40	0.006	0.016						
D	3.30	3.95	0.130	0.156						
E	5.10	5.60	0.201	0.220						
E1	4.05	4.60	0.159	0.181						
L	0.75	1.50	0.030	0.059						

#### Table 3. SMB dimensions (values)



### Figure 12. Marking layout<sup>(1)</sup>



1. Marking layout can vary according to assembly location.



## 4 Ordering information

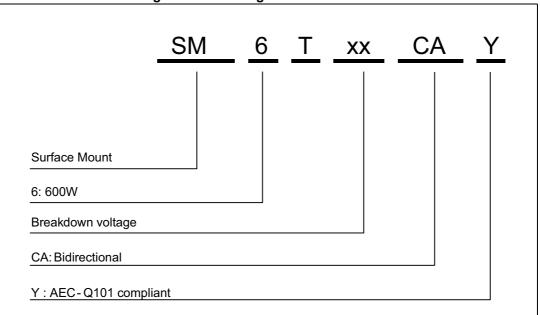


Figure 13. Ordering information scheme

#### Table 4. Ordering information

Order code	Marking	Weight	Base qty.	Delivery mode
SM6T250CAY	PRY	0.11 g	2500	Tape and reel

## 5 Revision history

Table 5	Document	revision	history
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Date	Revision	Changes			
19-Mar-2015	1	nitial release.			
09-Apr-2015	2	Jpdated <i>Figure</i> 7.			



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